

Description

Polypropylene PPH 12020 is a clarified high fluidity homopolymer with a Melt Flow Index of 60 g/min.

Polypropylene PPH 12020 has been designed with a very high stiffness and an outstanding transparency. It is suitable for the injection moulding of transparent packaging.

Characteristics

	Method	Unit	Typical Value
Rheological properties			
Melt Flow Index 230°C/2.16 kg	ISO 1133	g/10 min	60
Mechanical properties			
Tensile Strength at Yield	ISO 527-2	MPa	37
Elongation at Yield	ISO 527-2	%	8
Tensile modulus	ISO 527-2	MPa	1850
Flexural modulus	ISO 178	MPa	1800
Izod Impact Strength (notched) at 23°C	ISO 180	kJ/m ²	3.5
Charpy Impact Strength (notched) at 23°C	ISO 179	kJ/m ²	4
Hardness Rockwell - R-scale	ISO 2039-2		98
Thermal properties			
Melting Point	ISO 3146	°C	165
Vicat Softening Point	ISO 306	°C	
50N-50°C per hour			90
10N-50°C per hour			153
Heat Deflection Temperature	ISO 752	°C	
1.80 MPa - 120°C per hour			55
0.45 MPa - 120°C per hour			100
Other physical properties			
Density	ISO 1183	g/cm ³	0.905
Bulk Density	ISO 1183	g/cm ³	0.525

Handling and storage

Please refer to the safety data sheet (SDS) for handling and storage information. It is advisable to convert the product within one year after delivery provided storage conditions are used as given in the SDS of our product. SDS may be obtained from the website: www.totalpetrochemicals.biz

An Injection Moulding troubleshooting guide is available upon request.

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